



SDI Review Form 1.6

Journal Name:	Journal of Engineering Research and Reports
Manuscript Number:	Ms_JERR_54345
Title of the Manuscript:	Laser DAF Cut Augmentation for Thin Wafers
Type of the Article	Original Research Article

General guideline for Peer Review process:

This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound. To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

<http://www.sciencedomain.org/page.php?id=sdi-general-editorial-policy#Peer-Review-Guideline>

PART 1: Review Comments

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
Compulsory REVISION comments	<p>Dear Editor:</p> <p>The manuscript focused on the "Laser DAF Cut Augmentation for Thin Wafers", which is new novel and very useful in sensor fields. It is recommended to accept after major revision. However, some parts need to revise, which are listed below as follows. The main points need to revise before publication.</p> <p>[1] The new relate references are needed to add in the revised manuscript.</p> <p>[2] The authors investigate many parameters in this study. What is optimal condition in this work? Please explain and add it in the revised manuscript.</p> <p>[3] What are the important applications in this study? Please add in the revised manuscript.</p> <p>[4] Why does the laser use the Nd: YAG? Please explain in details.</p>	
Minor REVISION comments		
Optional/General comments		

PART 2:

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
Are there ethical issues in this manuscript?	<i>(If yes, Kindly please write down the ethical issues here in details)</i>	

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